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Texas Instruments

PCB Number: TIDA-01569  
PCB Rev: A



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Pb-Free Symbol

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FCC disclaimer

ZZ1

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

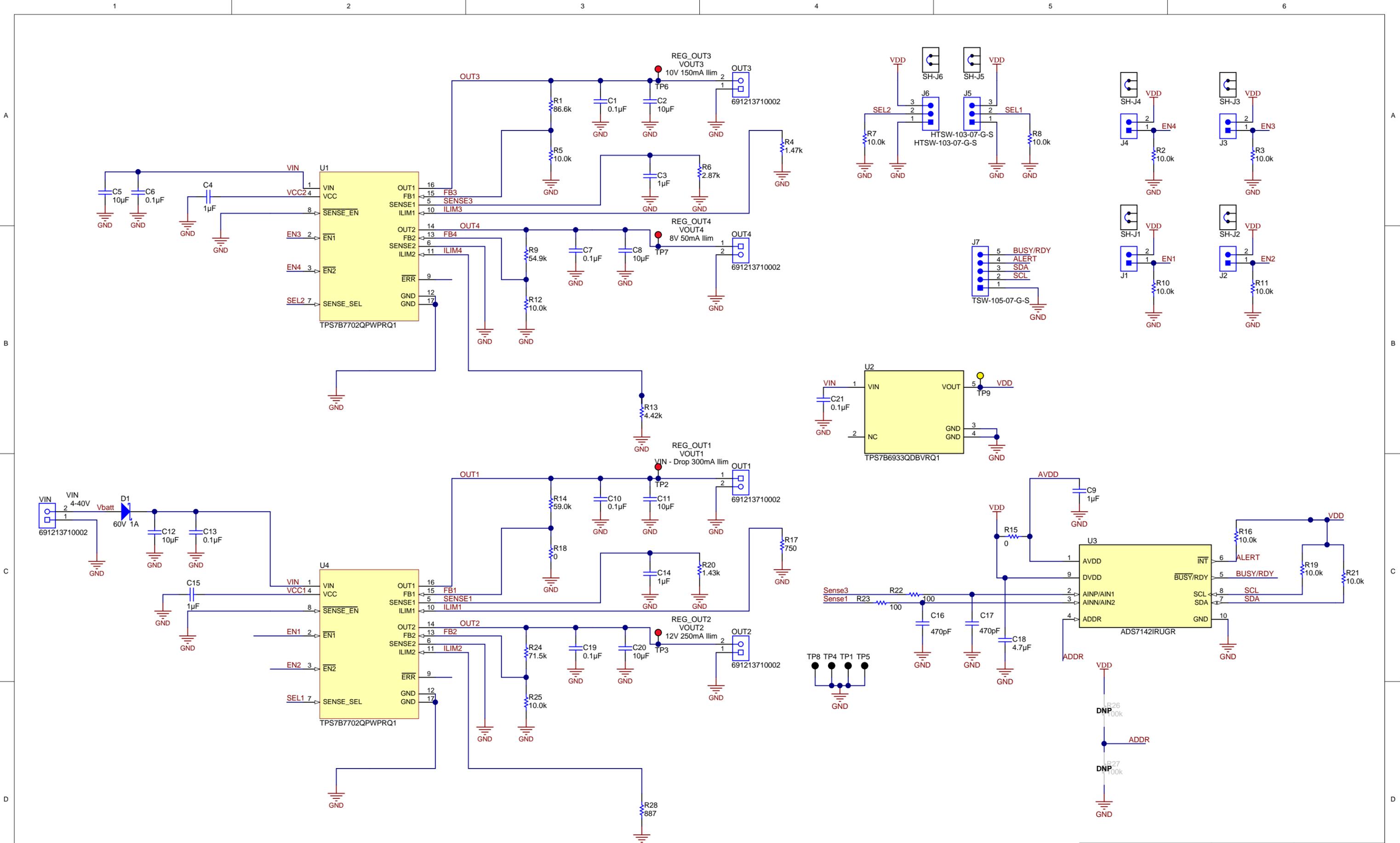
ZZ3

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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|-----------------------------------|-------------------------|--------------------------------------|--|---------------|--|
| Number: TIDA-01569                |                         | Rev: A                               | Designed for: Public Release   |               | Mod. Date: 10/2/2017   |
| SVN Rev: Version control disabled |                         | Project Title: 4 Channel Antenna LDO |  | Sheet Title:  |  |
| Drawn By:                         | Engineer: Logan Cummins | Assembly Variant: 001                | File: TIDA-01569A_Hardware.SchDoc  | Sheet: 1 of 1 | Size: B  |
|                                   |                         |                                      | Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a> |               | <br><a href="http://www.ti.com">http://www.ti.com</a><br>© Texas Instruments 2017 |



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|--|--------|--|--|
| Designed for: Public Release   |        | Mod. Date: 12/19/2017  |  |
| Project Title: 4 Channel Antenna LDO                                       |        |  |  |
| Sheet Title:   |        |  |  |
| Number: TIDA-01569   | Rev: A | Assembly Variant: 001  |  |
| SVN Rev: Version control disabled  |        | Sheet: 1 of 1  |  |
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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
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